Docket No.	
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## **Declaration for U.S. Patent Application**

			Y Y	
As a below named	d inventor, I hereby declare the	at:		
My residence, pos	st office address and citizensh	ip are as stated below r	next to my name.	
names are listed b	elow) of the subject matter wh	hich is claimed and for	listed below) or an original, first and jo which a patent is sought on the invent BLE MAIN SPINDLE	
the specification of	of which is attached hereto unl	less the following is ch	ecked	
Li	was filed on	as United	d States Application Number and was amended on _	or
•	I have reviewed and understa mendment referred to above.	nd the contents of the	above-identified specification, including	g the claim(s), as
I acknowledge the § 1.56.	e duty to disclose information	which is material to pa	tentability as defined in Title 37, Code	of Federal Regulations,
inventor's certifica		identified below any fo	ode, § 119 (a) - (d) of any foreign apporeign application for patent or inventor	
(List prior foreign applications.	JP2 <u>002-280411</u> (Number)	Japan (Country)	26/September/2002 (Day/Month/Year Filed)	Priority Claimed X Yes No
See note A on back of this	(Number)	(Country)	(Day/Month/Year Filed)	Yes No Yes No
page)	(Number)	(Country)	(Day/Month/Year Filed)	Yes No
	(Number)	(Country)	(Day/Month/Year Filed)	
(See note B on back	ck of this page)	See attached list for ac	lditional prior foreign applications	
subject matter of e the first paragraph as defined in Title	each of the claims of this appli of Title 35, United States Code	cation is not disclosed e, § 112, I acknowledge ons, § 1.56 which beca	any United States application(s) listed in the prior United States application i the duty to disclose information which me available between the filing date of	n the manner provided by is material to patentability
(List Prior U.S. Applications)	(Appln. Serial No.)	(Filing Date)	(Status: Patented, Pending, Aba	andoned)
PF	(Appln. Serial No.)	(Filing Date)	(Status: Patented, Pending, Aba	
	(Appln. Serial No.)	(Filing Date)	(Status: Patented, Pending, Aba	indoned)

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:



Please direct all communications to the following address:



PATENT TRADEMARK OFFICE

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

(See note C		ne, family name) <u>Takashi SHIMADA</u>				
above)	Inventor's signature Takashi Shi	nada Date September 16, 2003				
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		Date				
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		Date				
		Citizenship				
Post Office Addre	ess					
Full name of fifth	inventor (given name, family name)					
Inventor's signatu	re	Date				
		Citizenship				
Post Office Addre	ess					
Full name of sixth	n inventor (given name, family name)					
Inventor's signatur	re	Date				
Residence		Citizenship				
Post Office Addre	ess					
Full name of seve	nth inventor (given name, family name)					
Inventor's signatur	re	Date				
		Citizenship				
Post Office Addre	ess					
Rev. 11/00						

## **NOTES**

- A. Please list all foreign applications relating to the invention and check block "yes" or "no".
- B. If more than 4 prior foreign applications, please check this box and attach a sheet listing the remaining prior foreign applications.
- C. For residence in the U.S., indicate <u>city and state</u>, for residence outside the U.S., indicate <u>city and country</u>. The "Post Office Address" must be an address acceptable by a Post Office for delivery of mail.